



## MS AMENDMENT

PATENT 0171-1022P

### IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:

Takeshi KINSHO et al. Conf.:

6775

Appl. No.:

10/671,732

Group:

1752

Filed:

September 29, 2003

Examiner: Sin J. LEE

For:

POLYMERIZABLE

SILICON-CONTAINING

COMPOUND,

MANUFACTURING METHOD, POLYMER, RESIST COMPOSITION

AND PATTERNING PROCESS

# LARGE ENTITY TRANSMITTAL FORM

#### MS AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 April 20, 2005

### Sir:

Transmitted herewith is an amendment in the above-identified application.

The enclose	ed document	is	being	transmi	tted	via	the	Certificate
of Mailing	provisions	of	37 C.	F.R. §	1.8.			

The enclosed document is being transmitted via facsimile.

The fee has been calculated as shown below:

	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR		PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL	17	-	20	=	0	\$50	\$0.00
INDEPENDENT	4	-	3	=	1	\$200	\$200.00
☐ FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM \$360 \$0.00							
						TOTAL	\$200.00

		month(s) extension of time pursuant to 1.136(a). \$0.00 for the extension of					
	No fee is required.						
$\boxtimes$	Check(s) in the amount of \$200.00 is(are) enclosed.						
	Please charge Deposit Account No. 02-2448 in the amount o \$0.00. This form is submitted in triplicate.						
overp requi	arrent, and future repli payment to Deposit Accour						
		Respectfully submitted,					
		BIRCH, STEWART, KOLASCH & BIRCH, LLP					
		By Angrew D. Meikle, #32,868					
ADM/k	osh -1022P	P.O. Box 747 Falls Church, VA 22040-0747 (703) 205-8000					

Attachment(s)



MS AMENDMENT

PATENT 0171-1022P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:

Takeshi KINSHO et al. Conf.:

6775

Appl. No.:

10/671,732

Group:

1752

Filed:

September 29, 2003

Examiner: Sin J. LEE

For:

POLYMERIZABLE SILICON-CONTAINING COMPOUND,

MANUFACTURING METHOD, POLYMER, RESIST COMPOSITION AND PATTERNING PROCESS

REPLY UNDER 37 C.F.R. § 1.111

MS AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

April 20, 2005

Sir:

In reply to the Office Action dated January 25, 2005, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This reply includes amendments to the claims and remarks.

04/21/2005 MBEYENE1 00000084 10671732

01 FC:1201

200.00 OP